

### Product Change Notification / RMES-23FLBS013

## Date:

01-Jul-2022

# **Product Category:**

8-bit Microcontrollers

# PCN Type:

Manufacturing Change

### **Notification Subject:**

CCB 3296.002 Final Notice: Qualification of MTAI as a new assembly site for selected ATMEGA1284x, ATMEGA16xxx, ATMEGA32xxx, ATMEGA644xx and ATMEGA85x5x device families available in 44L TQFP (10x10x1mm) package.

### Affected CPNs:

RMES-23FLBS013\_Affected\_CPN\_07012022.pdf RMES-23FLBS013\_Affected\_CPN\_07012022.csv

### Notification Text:

PCN Status: Final Notification

PCN Type: Manufacturing Change

**Microchip Parts Affected:**Please open one of the files found in the Affected CPNs section. Note: For your convenience Microchip includes identical files in two formats (.pdf and .xls)

**Description of Change:**Qualification of MTAI as a new assembly site for selected ATMEGA1284x, ATMEGA16xxx, ATMEGA32xxx, ATMEGA644xx and ATMEGA85x5x device families available in 44L TQFP (10x10x1mm) package.

### Pre and Post Change Summary:

	Pre Change	Post Change					
Assembly Site	Lingsen Precision Industries, LTD. (LPI)	Microchip Technology Thailan (HQ (MTAI)					
Wire Material	CuPdAu or Au	Au					
Die Attach Material	CRM-1033BF	3280					
Molding Compound Material	G700	G700					
Lead-Frame Material	C7025	C7025					
Lead-Frame Paddle Size	160x160 or 205x205 or 275x275	180x180 or 275x275					
DAP Surface Prep	Ag plated	Bare Cu					
Tray Comparison	Black Tray (Bakeable)	Black Tray (Bakeable) or					
		Blue Tray (Non-Bakeable)					
	See attached Pre and Post Change comparison						
Moisture Sensitivity Level							
(MSL)	MSL 3	MSL 1					
Classification Level							

### Impacts to Data Sheet:None

### Change ImpactNone

**Reason for Change:**To improve manufacturability and on-time delivery performance by qualifying MTAI as a new assembly site.

#### Change Implementation Status: In progress

Estimated First Ship Date: July 15, 2022 (date code: 2229)

Note: Please be advised that after the estimated first ship date customers may receive pre and post change parts.

### Time Table Summary:

	June 2022					July 2022					
Workweek	2 3	2 4	2 5	2 6	2 7	2 8	2 9	3 0	3 1	3 2	
Qual Report				х							

Availability						
Final PCN Issue		v				
Date		X				
Estimated						
Implementation				х		
Date						

Method to Identify Change: Traceability code

**Qualification Report:**Please open the attachments included with this PCN labeled as PCN\_#\_Qual\_Report.

#### **Revision History:**

**June 24, 2022:** Issued final notification. Attached is the qualification report and provided estimated first ship date by July 15, 2022.

**July 01, 2022:** Re-issued final notification. Added MSL Classification Level and Tray comparison in Pre and Post change summary table. Added attachment file (ppt) for Tray comparison.

The change described in this PCN does not alter Microchip's current regulatory compliance regarding the material content of the applicable products.

### Attachments:

PCN\_RMES-23FLBS013\_Pre and Post Change\_Summary.pdf PCN\_RMES-23FLBS013\_Qual Report.pdf

Please contact your local Microchip sales office with questions or concerns regarding this notification.

#### **Terms and Conditions:**

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If you wish to <u>change your PCN profile</u>, <u>including opt out</u>, please go to the <u>PCN home page</u> select login and sign into your myMicrochip account. Select a profile option from the left navigation bar and make the applicable selections. RMES-23FLBS013 - CCB 3296.002 Final Notice: Qualification of MTAI as a new assembly site for selected ATMEGA1284x, ATMEGA16xxx, ATMEGA32xxx, ATMEGA644xx and ATMEGA85x5x device families available in 44L TQFP (10x10x1mm) package.

Affected Catalog Part Numbers (CPN)

ATMEGA644PA-AN ATMEGA644PA-ANR ATMEGA644-20AU ATMEGA644V-10AU ATMEGA644-20AUR ATMEGA644V-10AUR ATMEGA324PV-10AU ATMEGA324P-20AU ATMEGA324P-20AQR ATMEGA324P-20AUR ATMEGA644PV-10AU ATMEGA644P-20AU ATMEGA644PV-10AQ ATMEGA644PV-10AQR ATMEGA644PV-10AUR ATMEGA644P-20AUR ATMEGA1284-AU ATMEGA1284-AUR ATMEGA324PA-AN ATMEGA324A-AURA3 ATMEGA16-16AU ATMEGA16-16AUA2 ATMEGA16L-8AU ATMEGA16-16AUR ATMEGA16L-8AUR ATMEGA32-16AU ATMEGA32L-8AU ATMEGA32A-AURA5 ATMEGA32L-8AUR ATMEGA164A-AUA2 ATMEGA164PA-AN ATMEGA164PA-ANR ATMEGA164A-AURA2 ATMEGA8515-16AUR ATMEGA8535-16AU ATMEGA8535L-8AU ATMEGA8535-16AUR ATMEGA8535L-8AUR ATMEGA32-16AUA3 ATMEGA32L-8AUA3 ATMEGA32-16AQ ATMEGA32-16AQR ATMEGA32L-8AURA0 ATMEGA32L-8AURA2 ATMEGA32L-8AURA4 ATMEGA164P-20AQ

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ATMEGA164P-20AQRA1